505907176 02/10/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT5953893 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TATSUKI WATANABE	01/31/2020
KATSUHIKO KOBAYASHI	01/31/2020

RECEIVING PARTY DATA

Name:	TYCO ELECTRONICS JAPAN G.K.	
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Internal Address:	KANAGAWA	
City:	KAWASAKI-SHI	
State/Country:	JAPAN	
Postal Code:	213-8535	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16785081

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ATTORNEY DOCKET NUMBER: 21334-2971

NAME OF SUBMITTER: SALVATORE ANASTASI

SIGNATURE: /Salvatore Anastasi/

DATE SIGNED: 02/10/2020

Total Attachments: 1

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PATENT 505907176 REEL: 051764 FRAME: 0393

IP Portal 06-Feb-2020 Our Ref.: P222822.US.01 Client Ref.: TE-01308AUS

Attorney Docket No.: 21334-2971

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:
this declaration is directed to inventions and improvements disclosed in:
the attached application, or
☐ United States application or PCT international application number filed
on, entitled <u>Connector Assembly</u> ("the APPLICATION)
The APPLICATION was made or authorized to be made by me;
I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;
I have reviewed and understand the contents of the APPLICATION, including the claims, and I an aware of the duty to disclose to the United States Patent and Trademark Office all information knows to me to be material to patentability as defined in 37.C.F.R 1.56; AND
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.
As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:
Tyco Electronics Japan G.K. ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of Japan having their principal place of business at 3-5-8 Hisamoto, Takatsu-ku, Kawasaki-shi, Kanagawa, 213-8535, Japan,
for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
WATANABE, Tatsuki	J. Waterrale	2020, JAN, 3/
KOBAYASHI, Katsuhiko	16 Hober chi	1/31/20